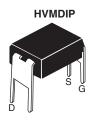
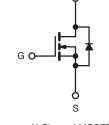
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	60			
R _{DS(on)} (Ω)	$V_{GS} = 5 V$	0.20		
Q _g (Max.) (nC)	8.4			
Q _{gs} (nC)	2.6			
Q _{gd} (nC)	6.4			
Configuration	Single			





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- For Automatic Insertion
- · End Stackable
- Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain servers as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRLD014PbF
	SiHLD014-E3
SnPb	IRLD014
	SiHLD014

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	60	V		
Gate-Source Voltage			V _{GS}	± 10	V		
Continuous Drain Current	V at 5 0 V	T _A = 25 °C	- I _D	1.7			
	V_{GS} at 5.0 V	T _A = 100 °C		1.2	А		
Pulsed Drain Current ^a			I _{DM}	14	1		
Linear Derating Factor				0.0083	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	490	mJ		
Maximum Power Dissipation	T _A = 25 °C		PD	1.3	W		
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	**		
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 197 mH, R_g = 25 Ω , I_{AS} = 1.7 A (see fig. 12).

c. $I_{SD} \leq 10$ A, $dI/dt \leq 90$ A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 175 \ ^{\circ}C.$

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply



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PARAMETER	SYMBOL	TYP		MAX.			UNIT	
			•					
Maximum Junction-to-Ambient	R _{thJA}	- 120			°C/W			
SPECIFICATIONS (T _J = 25 °C,	unless other	wise noted)						
PARAMETER	SYMBOL		T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static		1						1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.070	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μΑ	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 10 V$			-	-	± 100	nA
-			$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	25	μA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150 \text{ °C}$		-	-	250		
Drain-Source On-State Resistance		V _{GS} = 5.0 V	ID	= 1.0 A ^b	-	-	0.20	
	R _{DS(on)}	V _{GS} = 4.0 V		= 0.85 A ^b	-	-	0.28	Ω
Forward Transconductance	g _{fs}	V _{DS} =	= 25 V, I _D =	1.0 A ^b	1.9	-	-	S
Dynamic					1	1	1	
Input Capacitance	C _{iss}				-	400	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$ $V_{DS} = 25 V$ f = 1.0 MHz, see fig. 5		-	170	-		
Reverse Transfer Capacitance	C _{rss}			-	42	-		
Total Gate Charge	Qg				-	-	8.4	
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V		A, V _{DS} = 48 V ig. 6 and 13 ^b	-	-	2.6	nC
Gate-Drain Charge	Q _{gd}		see ng	J. 6 anu 13~	-	-	6.4	
Turn-On Delay Time	t _{d(on)}		I		-	9.3	-	
Rise Time	tr		00.14	10.4	-	110	-	1
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 30 \text{ V}, I_D = 10 \text{ A}$ $R_g = 12 \Omega, R_D = 2.8 \Omega, \text{ see fig. } 10^{\text{b}}$		-	17	-	ns	
Fall Time	t _f			-	26	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-		
Internal Source Inductance	L _S			-	6.0	-	- nH	
Drain-Source Body Diode Characteristic	s	•						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1.7	Δ	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	14	A	
Body Diode Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 1.7 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.6	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$		-	93	130	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.34	0.65	μC	
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time i	s negligible (turn	-on is don	ninated by	Leand	Ln)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

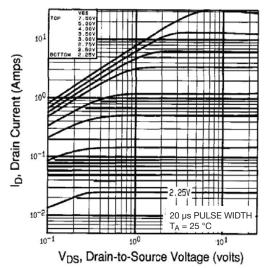


Fig. 1 - Typical Output Characteristics, $T_A = 25 \ ^{\circ}C$

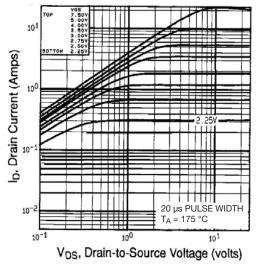


Fig. 2 - Typical Output Characteristics, $T_A = 175 \ ^{\circ}C$

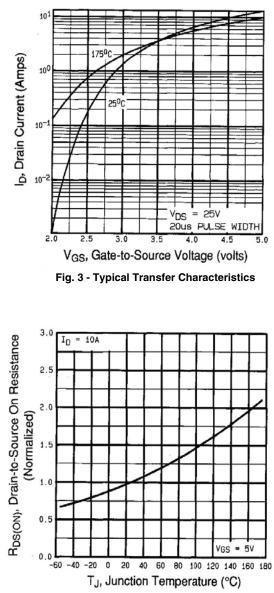


Fig. 4 - Normalized On-Resistance vs. Temperature

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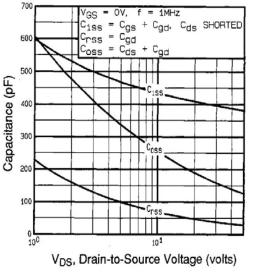


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

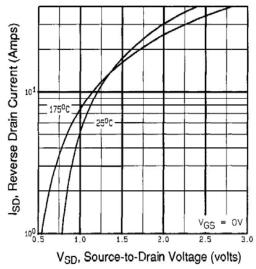


Fig. 7 - Typical Source-Drain Diode Forward Voltage

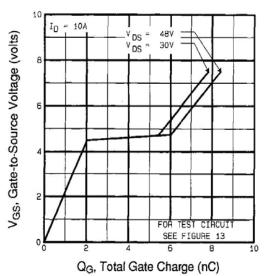
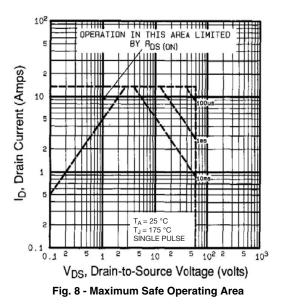


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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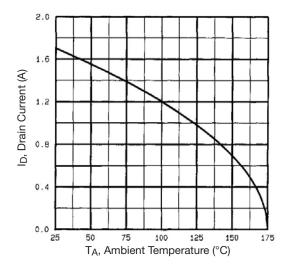


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

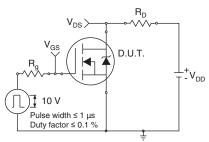


Fig. 10a - Switching Time Test Circuit

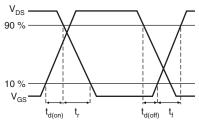


Fig. 10b - Switching Time Waveforms

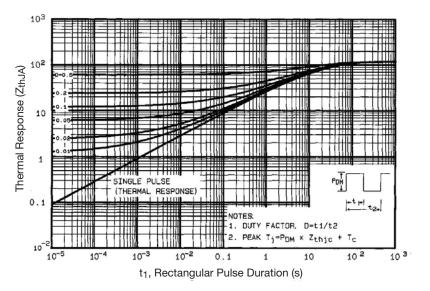


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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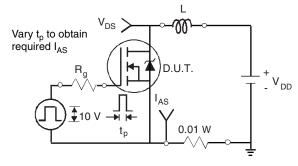


Fig. 12a - Unclamped Inductive Test Circuit

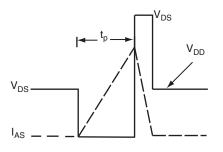
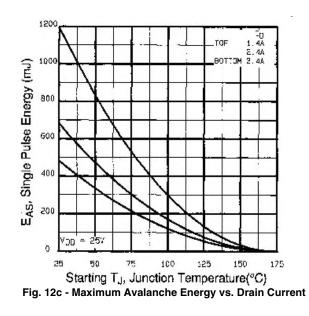


Fig. 12b - Unclamped Inductive Waveforms



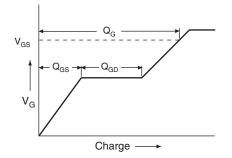


Fig. 13a - Basic Gate Charge Waveform

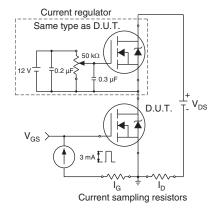


Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit

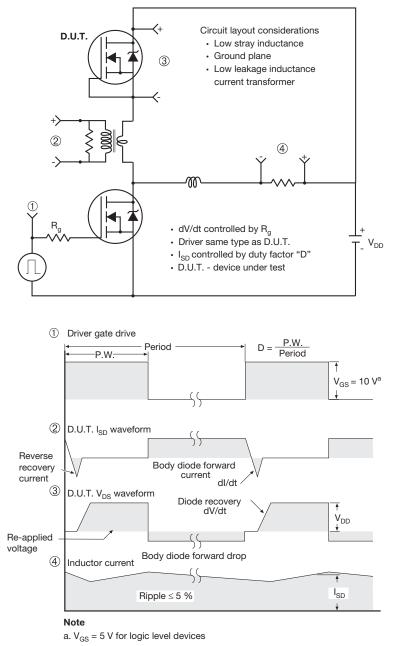


Fig. 14 - For N-Channel

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